

Title (en)
LIGHT-EMITTING DEVICE WITH METAL INLAY AND TOP CONTACTS

Title (de)
LICHTEMITTIERENDE VORRICHTUNG MIT METALLEINLAGE UND OBERKONTAKTEN

Title (fr)
DISPOSITIF ÉLECTROLUMINESCENT AVEC INCRUSTATION MÉTALLIQUE ET CONTACTS SUPÉRIEURS

Publication
EP 4186097 A1 20230531 (EN)

Application
EP 21846118 A 20210721

Priority

- US 202016934917 A 20200721
- EP 20190472 A 20200811
- US 2021042578 W 20210721

Abstract (en)
[origin: WO2022020474A1] Light-emitting devices are described herein. A device includes a hybridized device having a top surface and a bottom surface and a packaging substrate comprising a metal inlay in an opening on a top surface of the packaging substrate. The metal inlay is thermally coupled to the bottom surface of the hybridized device. The device also includes conductive contacts on the top surface of the packaging substrate and conductive connectors electrically coupled between the top surface of the hybridized device and the top surface of the packaging substrate.

IPC 8 full level
H01L 25/16 (2023.01); **H01L 23/482** (2006.01); **H01L 33/44** (2010.01); **H01L 33/62** (2010.01); **H01L 33/64** (2010.01)

CPC (source: EP)
H01L 23/3677 (2013.01); **H01L 25/167** (2013.01); **H01L 23/36** (2013.01); **H01L 25/0753** (2013.01); **H01L 33/62** (2013.01); **H01L 33/644** (2013.01)

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)
BA ME

Designated validation state (EPC)
KH MA MD TN

DOCDB simple family (publication)
WO 2022020474 A1 20220127; CN 116325197 A 20230623; EP 4186097 A1 20230531; EP 4186097 A4 20241009; JP 2023535909 A 20230822; JP 7472392 B2 20240422; KR 102572731 B1 20230831; KR 20230037663 A 20230316

DOCDB simple family (application)
US 2021042578 W 20210721; CN 202180064279 A 20210721; EP 21846118 A 20210721; JP 2023504248 A 20210721; KR 20237006104 A 20210721